

### **TFT DISPLAY SPECIFICATION**



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司

## Winstar Display Co., LTD 華凌光電股份有限公司

CUSTOMER



WEB: <a href="https://www.winstar.com.tw">https://www.winstar.com.tw</a> E-mail: sales@winstar.com.tw

#### **SPECIFICATION**

COSTOMER .	
MODULE NO.:	WF70C6TYAB5MNNO#
APPROVED BY:	
( FOR CUSTOMER USE ONLY )	PCB VERSION: DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
			葉虹蘭
ISSUED DATE:	2023/12/20		

This TFT Display item is for Economical Version TFT LCM Inspection Specification: https://www.winstar.com.tw/technology/download.html

Precaution in use of TFT module: <a href="https://www.winstar.com.tw/technology/download/declaration.html">https://www.winstar.com.tw/technology/download/declaration.html</a>

Winstar Display Co., LTD 華凌光電股份有限公司			MODLE NO :	
REC	ORDS OF REV	ISION		DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.	SU	MMARY
0	2023/12/20		Fi	rst issue



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# 1.Module Classification Information

W	F	70	C6	T	Y	A	B5	M	N	N	0	#
1	2	3	4	(5)	6	7	8	9	10	(11)	(12)	13)

①	Bran	d: WINSTA	AR D	ISPLA	Y CO	ORP	ORATI	ON							
2	Display Type: F→TFT Type, J→Custom TFT														
3	Display Size: 7.0" TFT														
4	Mod	el serials no													
(5)	Back	light	F→	CCFL,	Whi	ite				$T \rightarrow J$	LED,	Whit	ce		
9	Туре	:	$S \rightarrow$	LED, H	Iigh	Ligi	ht White	•		$Z \rightarrow J$	Z→Nichia LED, White				
	I CD	Polarize	A-	→Transn	nissi	ve, 1	N.T, IPS	TF	Γ	$Q \rightarrow$	Trans	missi	ve, Super V	W.T,	12:00
			$C \rightarrow$	Transn	issi	ve, ì	N. T, 6:0	0;		R→	Transı	missi	ve, Super V	<i>V</i> .T, 0	O-TFT
	Туре		$F \rightarrow$	Transm	issiv	ve, N	N.T,12:0	0;		$V \rightarrow$	Trans	missi	ive, Super V	W.T,	VA TFT
6	_	perature	I→'	Transm	issiv	e, W	7. T, 6:0	$\mathbf{C}$		W	Trans	miss	ive, Super	W.T,	IPS TFT
	-	e/ Gray	K→	Transf	lecti	ve, V	W.T,12:0	00		$X \rightarrow$	Trans	missi	ive, W.T, V	A TF	Т
		Inversion	$L \rightarrow$	Transm	issiv	ve, V	W.T,12:0	00		$Y \rightarrow$	Trans	missi	ive, W.T, IF	S TF	T
	Direc	ction	N-	∙Transn	nissi	ve, S	Super W	T.T, 6	:00	$Z \rightarrow Z$	Transı	nissi	ve, W.T, O	-TFT	
	A:	ΓFT LCD								F:	TFT+0	CON	TROL B	OAR	D
	B: TFT+SCREW HOLES+CONTROL BOARD G: TFT+ SCREW HOLES														
7	C: T	ΓFT+ SCRE	WΗ	OLES -	-A/Γ	BC	OARD			H:	TFT+	D/V	BOARD		
	$\mathbf{D}: 1$	ΓFT+ SCREW	HOL	ES +A/D	BOA	ARD-	+CONTR	OL B	OARI	$\Gamma:\Gamma$	FT+	SCR	EW HOLE	S +D	/V BOARD
	E : 7	ΓFT+ SCRE	W H	OLES +	-PO	WEI	R BOA	ARD		J: 7	rft+i	POW	ER BD		
	Reso	lution:					1						R		
	M	1024 <mark>7</mark> 68	N	12812	28	P	128 <mark>0800 Q</mark>		4808	800	R	640320	S	480128	
8	Т	8003 <mark>2</mark> 0	U	8 <mark>0</mark> 012	80	V	17622	20	W	1280	398	X	1024250	Y	1920720
	A5	192010 <mark>8</mark> 0	A6	48048	30	A7	108019	920	A8	1352	240	A9	480640	B2	122250
	В3	340800	B4	28014	24	B5	120019	920	В6	4801	280	В7	800800	B8	40160
9	D	): Digital	I	L:LVDS	5		M:MIP			E:eDP	)				
	Inter	face:													
10	N	Without co	ontro	l board	A		8Bit	В		16Bi	it	Е	eDP	Н	HDMI
	I	I2C In	terfa	ice	R	_	RS232	S	SI	PI Inte	rface	U	USB		
	TS:	-							11			ı	1		1
	N	Without TS				Т	Resistiv	e to	ich p	anel	CC	Capac	itive touch	pane	el (G-F-F)
(11)	G	Capacitive to	ouch	panel (	G-G	•)			C1	Capa	citive	touc	h panel (G-	-F-F)	+OCA
	C2	Capacitive to	ouch	panel (	G-F-	-F)+	OCR		G1	Capa	citive	touc	h panel (G-	-G)+	OCA
	G2	Capacitive to	ouch	panel (	G-G	)+O	CR		В	CTP-	+GG+	USE	}		
12	Vers	sion:	X:Ra	spberry	pi		V: I	Rasp	berry	pi 3B	+				
	G					RO	HS dire								
13	Spec	ial Code							Č						
	1														

### 2.Summary

The TFT 7.0" is a color active matrix a-Si CD FOG, using a-Si (amorphous silicon )TFTs (Thin Film Transistors) as an active switching devices. The FOG has a 7.02 inch diagonally measured active area with 1200×1920resolutions (1200 horizontal by 1920 vertical pixel array). Each pixel is divided into RED, GREEN, BLUE dots which are arranged in vertical stripe and this FOG can display 16.7M colors.



### **3.General Specifications**

Item	Dimension	Unit				
Size	7.0	inch				
Dot Matrix	1200 x RGB x 1920 (TFT)	dots				
Module dimension	112.1 x 163.75 x 2.4	mm				
Active area	94.5 x 151.2	mm				
Pixel Pitch	0.07875 X 0.07875	mm				
LCD type	TFT, Normally Black, Transmissive					
Viewing Angle	80/80/80					
Aspect Ratio	10:16					
Color arrangement	RGB-STRIPE					
TFT Driver IC	HX8279-D01*2 Cascade or equiva	lent				
TFT Interface	4-Lanes MIPI					
Backlight Type	LED ,Normally White					
With /Without TP	Without TP	10				
Surface	Glare					

<sup>\*</sup>Color tone slight changed by temperature and driving voltage.

### **4.Absolute Maximum Ratings**

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	TOP	-20	_	+70	°C
Storage Temperature	TST	-30	_	+80	°C

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

1. Temp.  $\,$  60°C, 90% RH MAX. Temp.  $>\!60^{\circ}\text{C}$  , Absolute humidity shall be less than 90% RH at  $60^{\circ}\text{C}$ 



### **5.Electrical Characteristics**

#### 5.1. Operating conditions:

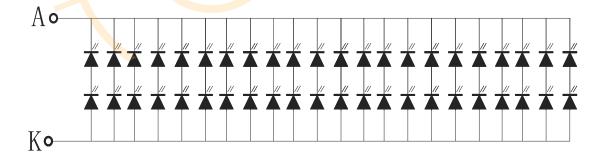
lte	em	Symbol	Min	Тур	Max	Unit	Notes	
		IOVCC	1.7	1.8	2.0	V		
Power Supply Input Voltage		VSP	4.5	-	6.0	V	Ta=25º Note 1	
		VSN	-		-4.5	V		
	Operating	IOVCC	39.4	40.3	41.3	mA		
		VSP	16.8	17.2	17.7	mA		
Current		VSN	12.9	13.3	13.7	mA		
Consumption	Sleep in	IOVCC	1.58	1.59	1.61	mA		
		VSP	2.04	2.05	2.06	mA		
		VSN	0.045	0.05	0.052	mA		

#### Note 1:

5.2. LED driving conditions

Parameter	Parameter Symbol		Min. Typ.		Unit	Remark	
LED current	-	-	440	-	mA	_	
LED voltag <mark>e</mark>	Α	5.2	6.0	6.8	V	Note 1	
LED Life T <mark>i</mark> me	-	-	50K		Hr	Note 2,3,4	

Note 1 : There are 1 Groups LED



Note 2 : Ta = 25 °C

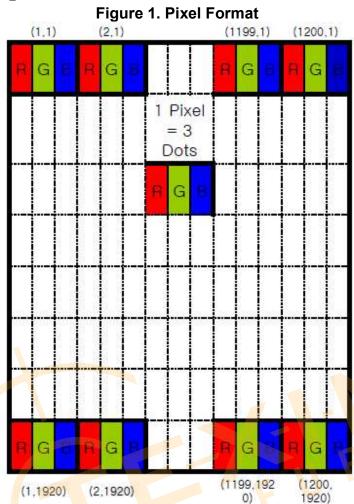
Note 3: Brightness to be decreased to 50% of the initial value

Note 4: The single LED lamp case

<sup>1.</sup>This is the voltage range of the IC. In this range, when the voltage is too low, the brightness of LCD may decrease

<sup>2.</sup>If the product needs to use the H1line screen, the power needs to be greater than or equal to 1w

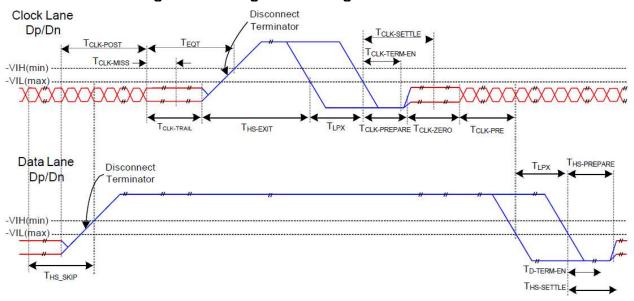
### **6.Data Input Format**



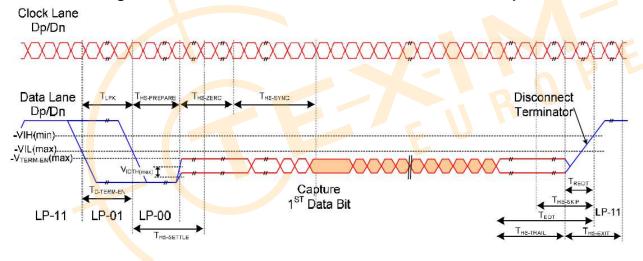
Display Position of Input Data (V-H)

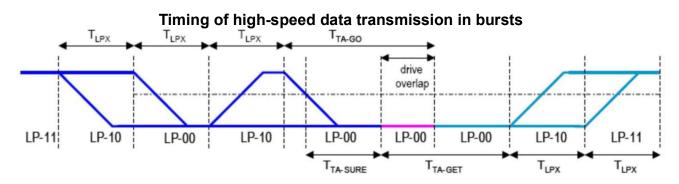
### 7.MIPI Interface Timing

Figure 2. Timing Chart of Signals in MIPI Interface



#### Switching the clock lane between clock transmission and low-power mode





**Turnaround Procedure** 

#### **MIPI Interface Timing**

	100000000000000000000000000000000000000	Spec.					
Parameter	Description	Min.	Тур.	Max.	Uni		
TREOT	30%-85% rise time and fall time	2	2	35	ns		
Tclk-Miss	Timeout for receiver to detect absence of Clock transitions and disable the Clock Lane HS-RX.	р Б	п	60	ns		
Tclk-post*1	Time that the transmitter continues to send HS clock after the last associated Data Lane has t ransitioned to LP Mode. Interval is defined as the period from the end of THS-TRAIL to the beginning of TCLK-TRAIL	60 ns + 52*UI (For DCS)			ns		
T <sub>CLK-PRE</sub>	Time that the HS clock shall be driven by the transmitter prior to any associated Data Lane beginning the transition from LP to HS mode.	8 -		+	ns		
TCLK-SETTLE	Time interval during which the HS receiver shall ignore any Clock Lane HS transitions, starting from the beginning of TCLK-PRE.	95	Ξ	300	ns		
T <sub>CLK</sub> -TERM-EN	Time for the Clock Lane receiver to enable the HS line termination, starting from the time point when Dn crosses V <sub>IL,MAX</sub> .	Time for Dn to reach VTERM-EN	_	38	ns		
THS-SETTLE	Time interval during which the HS receiver shall ignore any Data Lane HS transitions, starting from the beginning of Theorems.	85 ns + 6*UI		145 ns + 10*UI	ns		
Теот	Time from start of Ths-TRAIL OF TOLK-TRAIL period to start of LP-11 state	-	-	105ns+48*UI			
T <sub>HS-EXIT</sub> (1)	time to drive LP-11 after HS burst	100	- 7		ns		
T <sub>HS-PREPARE</sub>	Time to drive LP-00 to prepare for HS transmission	40ns + 4*UI	2	85ns+6*UI	ns		
THS-PREPARE + THS-ZERO	THS-PREPARE + Time to drive HS-0 before the Sync sequence	145ns + 10*UI	+	*	ns		
THS-SKIP	Time-out at RX to ignore transition period of EoT	40	8	55ns+4*UI	ns		
THS-TRAIL	Time to drive flipped differential state after last payload data bit of a HS transmission burst	60 + 4*UI	ą	-	ns		
TLPX	Length of any Low-Power state period	50	- 5	· = ·	ns		
Ratio T <sub>LPX</sub>	Ratio of TLPX(MASTER)/TLPS(SLAVE) between Master and Slave side	2/3	9	3/2	20		
TTA-GET	Time to drive LP-00 by new TX	5*TLPX					
TTA-GO	Time to drive LP-00 after Turnaround Request	6) 8		ns			
T <sub>TA-SURE</sub>	Time-out before new TX side starts driving	T <sub>LPX</sub>	=	2*T <sub>LPX</sub>	ns		

**Note:** (1) For image transmission:

TCLK-POST min value =164 when MIPI max frequency per lane = 0.53Gbps. TCLK-POST min value =112 when MIPI max frequency per lane =1Gbps

### 8. Porch setting & Reset Timing

#### 8.1. Porch setting

Parameter	Symbol	Min.	Тур.	Max.	Unit
Horizontal Sync. Width	hpw	10	24	-	Clock
Horizontal Sync. Back Porch	hbp	50	80	- 1	Clock
Horizontal Sync. Front Porch	hfp	20	60	-	Clock
Vertical Sync. Width	VS	12	2	- = 0	Line
Vertical Sync. Back Porch	vbp	-	10	<b>.</b>	Line
Vertical Sync. Front Porch	vfp		14	-	Line

#### 8.2. Reset Timing:

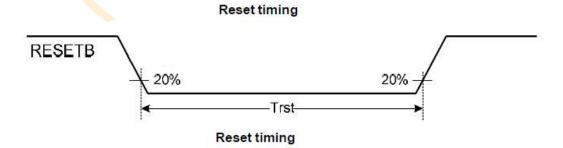
When RESETB of the reset pin equals to Low, it will be in the condition of reset. When it is in the condition of reset, it will make the device recover the initial set.

However, in order to avoid the reset noise cause reset, there is a mechanism to judge about whether the reset is needed or not.

The closed interval of low can be shown as the following.

(IOVCC=1.7V~2.0V, VSS=0V, TOPR=-20°C~+85°C)

Barratar	Sbal	Camaliaiana		Unit			
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Reset low pulse width	Trst	( <u>-</u>	20	8 <del>-</del> 2	( <b>-</b> )	us	

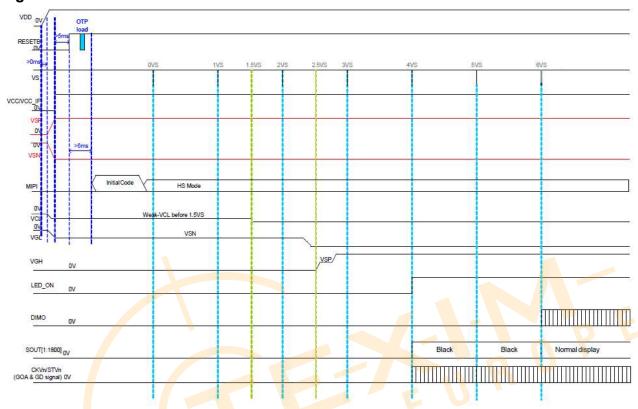


### 9.Power Sequence

#### 9.1. Power ON/OFF Sequence

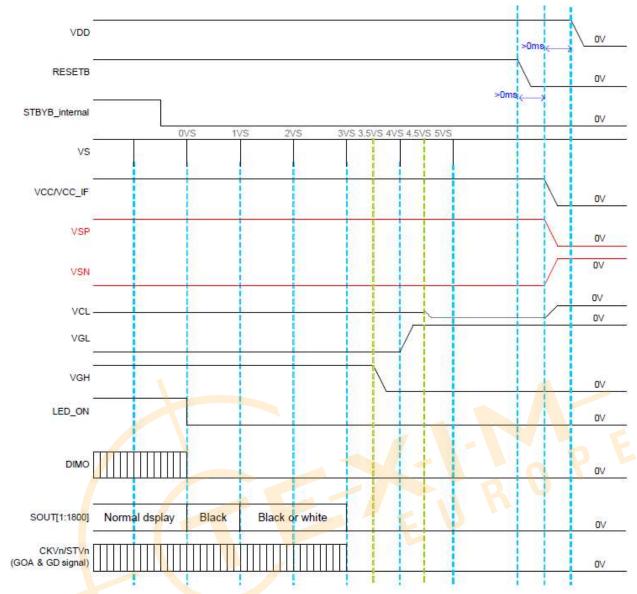
To prevent a latch-up or DC operation of the LCD FOG, the power on/off sequence shall be as shown in below

Figure 3. Power on/off



**Note:** (1) Finish to write the GOA MUX (page1 registers) and GOA timing setting (page3 registers) within 50ms after reset pulls to high.

Power on sequence with PWRMD=0 and repair OP disable



Power off sequence with PWRMD=0

### **10.Optical Characteristics**

Item		Symbol	Condition.	Min	Тур.	Max.	Unit	Remark
Response time		Tr+ Tf	θ=0°, Φ=0°	-	30	40	.ms	Note 3
Contrast ratio		CR	At optimized viewing angle	1000	1200	-	-	Note 4
Color	White	Wx	θ=0°、Ф=0	0.235	0.285	0.335	-	Note
Chromaticity		Wy		0.269	0.319	0.369	-	2,5,6
Viewing angle	Hor.	ΘR	CR≧10	75	80	-	Deg.	Note 1
		ΘL		75	80	-		
	Ver.	ΦТ		75	80	-		
		ФВ		75	80	-		
Brightness		-	-	400	500	-	cd/m²	Center of display
Uniformity		(U)	-	70	-	-	%	Note 5

Ta=25±2°C, IL=440mA

Note 1: Definition of viewing angle range

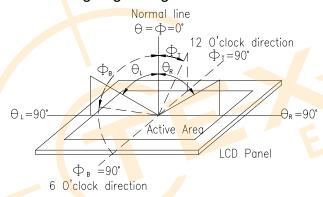


Fig. 10.1. Definition of viewing angle

Note 2: Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7orBM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.

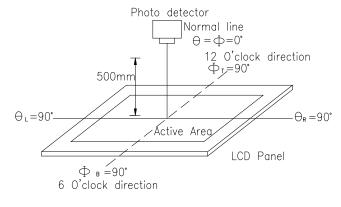
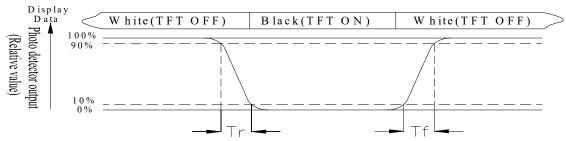


Fig. 10.2. Optical measurement system setup

#### Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time, Tr, is the time between photo detector output intensity changed from 90%to 10%. And fall time, Tf, is the time between photo detector output intensity changed from 10%to 90%



Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

Contrast ratio (CR) = Luminance measured when LCD on the "White" state

Luminance measured when LCD on the "Black" state

#### Note 5: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (reference the picture in below). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (U) = Lmin/Lmax x100%

L = Active area length

W = Active area width

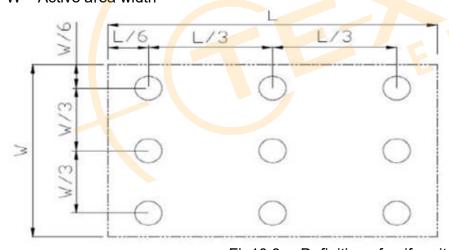


Fig10.3. Definition of uniformity

Note 6: Definition of color chromaticity (CIE 1931) Color coordinates measured at the center point of LCD

Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

### 11.Interface

#### 11.1. LCM PIN Definition

Pin	Symbol	Function	Remark	
1	NC	No connection		
2	IOVCC	Power supply for system ,IOVCC=1.8V		
3	IOVCC	Power supply for system ;10 vcc-1.6v		
4	GND	Ground		
5	RESET	Device reset signal		
6	NC	No connection		
7	GND	Ground		
8	D0N	MIPI Negative data signal (-)		
9	D0P	MIPI Positive data signal (+)		
10	GND	Ground		
11	D1N	MIPI Negative data signal (-)		
12	D1P	MIPI Positive data signal (+)		
13	GND	Ground		
14	CLKN	MIPI Negative clock signal (-)	a E	
15	CLKP	MIPI Positive clock signal (+)		
16	GND	Ground		
17	D2N	MIPI Negative data signal (-)		
18	D2P	MIPI Positive data signal (+)		
19	GND	Ground		
20	D3N	MIPI Negative data signal (-)		
21	D3P	MIPI Positive data signal (+)		
22	GND	Ground		
23	NC	No connection		
24	NC	No connection		
25	GND	Ground		
26	NC/TE	Sync signal for touch panel. Float it if not used.		
27	PWMO	PWM control signal for LED driver		
28	NC/BIST	Enable the Test Image Generation function, if connect to ground. Float it if not used.		
29	NC	No connection		
30	GND	Ground		

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31	VLED-	LED cathode	
32	VLED-	LED Catriode	
33	NC	No connection	
34	VSN	Analog cupply pagative voltage	
35	VSN	Analog supply negative voltage	
36	NC	No connection	
37	VSP	Analog cupply positive voltage	
38	VSP	Analog supply positive voltage	
39	VLED+	LED anode	
40	VLED+	LED alloue	



### 12.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

Environmental Test						
Test Item	Content of Test	Test Condition	Note			
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2			
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2			
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs				
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1			
High Temperature/ Humidity Operation	The module should be allowed to stand at 60°C,90%RH max	60°C,90%RH 96hrs	1,2			
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C  30min 5min 30min 1 cycle	-20°C/70°C 10 cycles				
Vibration te <mark>s</mark> t	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3			
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330Ω CS=150pF 10 times				

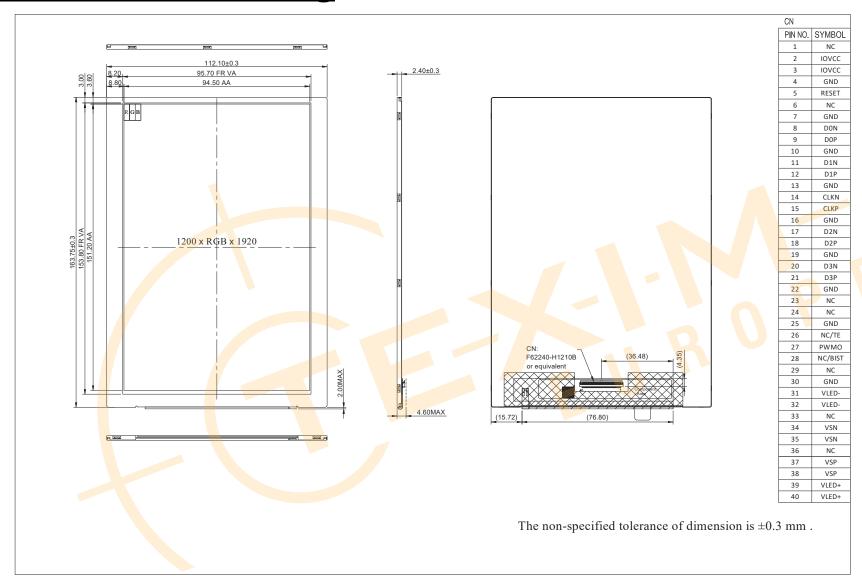
Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

### **13.Contour Drawing**





vinsta 10dul	r <u>LCM Sampl</u> • Number :	e Estimate F	Feedback Sheet
	anel Specification:		Page: 1
	Panel Type :	□ Pass	□ NG ,
	View Direction:	□ Pass	□ NG ,
3	Numbers of Dots:	□ Pass	□ NG ,
4.	View Area:	□ Pass	□ NG ,
	Active Area:	□ Pass	□ NG ,
6.	Operating	□ Pass	□ NG ,
	Storage Temperature :	□ Pass	□ NG ,
	Others:		
2 · <u>N</u>	<u>lechanical</u>		
1.	PCB Size :	□ Pass	□ NG ,
2.	Frame Size :	□ Pass	□ NG ,
3.	Material of Frame:	□ Pass	□ NG ,
4.	Connector Position:	□ Pass	□ NG ,
5.	Fix Hole Position:	□ Pass	□ NG ,
6.	Backlight Position:	□ Pass	□ NG ,
7.	Thickness of PCB:	□ Pass	□ NG ,
8.	Height of Frame to	□ Pass	□ NG ,
9.	Heig <mark>h</mark> t of Module:	□ Pass	□ NG ,
10	. Oth <mark>e</mark> rs:	□ Pas <mark>s</mark>	□ NG ,
3 · <u>F</u>	Relat <mark>ive Hole Size</mark> :		
1.	Pitch of Connector:	□ Pass	□ NG ,
2.	Hole size of Connector:	□ Pass	□ NG ,
3.	Mounting Hole size:	□ Pass	□ NG ,
	Mounting Hole Type:	□ Pass	□ NG ,
_	Others:	□ Pass	□ NG ,
	Sacklight Specification:		
	B/L Type:	□ Pass	□ NG ,
	B/L Color:	□ Pass	□ NG ,
	B/L Driving Voltage (Refer		□ Pass □ NG ,
	B/L Driving Current:		□ NG ,
	Brightness of B/L:		□ NG ,
	B/L Solder Method:		□ NG ,
1.	Others:	□ Pass	•
		>> Go to pa	aye z < <

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•			
ar Module Number:			Page: 2
Electronic Characteristics	of Module :		
Input Voltage :	□ Pass	□ NG ,	
Supply Current:	□ Pass	□ NG ,	
Driving Voltage for LCD:	□ Pass		
Contrast for LCD:	□ Pass	□ NG ,	
B/L Driving Method:	□ Pass	□ NG ,	
Negative Voltage Output:	□ Pass	□ NG ,	
Interface Function:	□ Pass		
LCD Uniformity:	□ Pass		
ESD test:	□ Pass		
Others:	□ Pass		
Summary :			
		Date :	
	Electronic Characteristics Input Voltage: Supply Current: Driving Voltage for LCD: Contrast for LCD: B/L Driving Method: Negative Voltage Output: Interface Function: LCD Uniformity: ESD test: Others: Summary: signature:	Electronic Characteristics of Module:  Input Voltage:	Electronic Characteristics of Module  Input Voltage:

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It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application.

Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time.

All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts.

Please contact us if you have any questions about the contents of the datasheet.

This may not be the latest version of the datasheet. Please check with us if a later version is available.



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